

## Features

- Ideal for indication light on hand held products
- Long life and robust package
- Variety of lens types and color choices available
- ESD protection
- Package: 2000pcs / reel
- Moisture sensitivity level : level 2a
- RoHS compliant

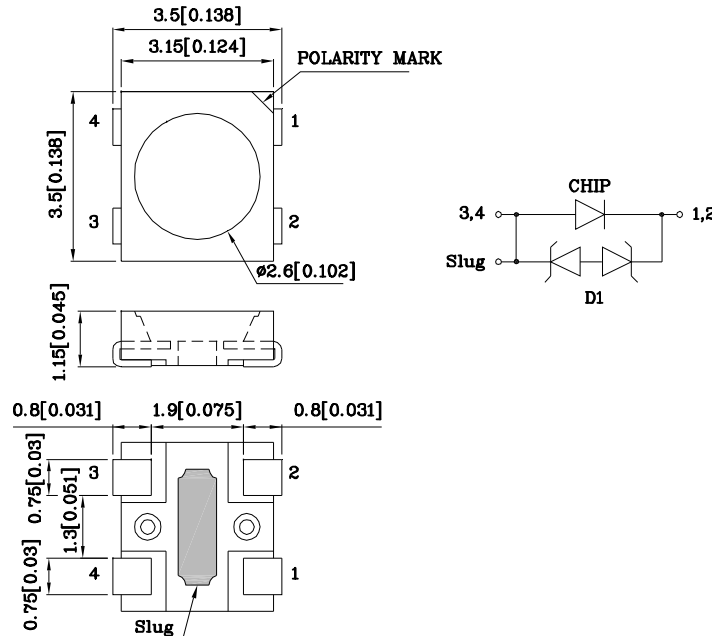
## Applications

- Signal and symbol luminaire for orientation.
- Marker lights (e.g. steps, exit ways, etc).
- Decorative and entertainment lighting.
- Commercial and residential lighting.
- Automotive interior lighting.



**ATTENTION**  
OBSERVE PRECAUTIONS  
FOR HANDLING  
ELECTROSTATIC  
DISCHARGE  
SENSITIVE  
DEVICES

## Package Schematics



### Notes:

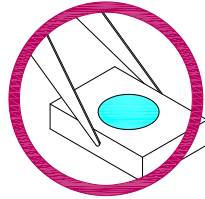
1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.25 (0.01)$  unless otherwise noted.
3. Specifications are subject to change without notice.

## Handling Precautions

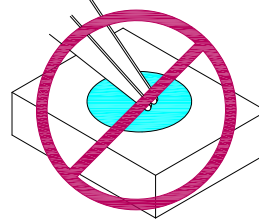
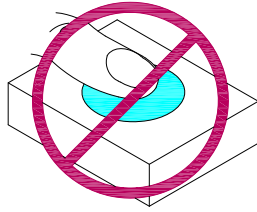
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

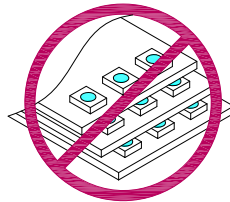
1. Handle the component along the side surfaces by using forceps or appropriate tools.



2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.



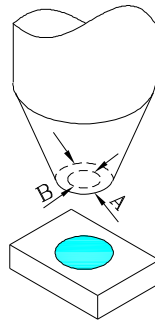
3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



4.1. The outer diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.

4.2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.

4.3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



5. As silicone encapsulation is permeable to gases, some corrosive substances such as H<sub>2</sub>S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=150mA) cd		Luminous Flux (IF=150mA) lm		Viewing Angle 2 θ 1/2 [2]
				min.	typ.	min.	typ.	
XZCB25X92S-4	Blue	InGaN	Water Clear	0.7	1.3	3.5	5	120°

**Absolute Maximum Ratings at TA=25°C**

Parameter	Symbol	Value	Unit
Power Dissipation	PD	600	mW
Junction Temperature [1]	TJ	110	°C
Operating Temperature	Top	-40 To +85	°C
Storage Temperature	Tstg	-40 To +85	°C
DC Forward Current[1]	IF	150	mA
Peak Forward Current [3]	IFM	300	mA
Reverse Voltage	VR	5	V
Thermal Resistance [1] (Junction/ambient)	Rth j-a	180	°C/W
Thermal Resistance [1] (Junction/solder point)	Rth j-S	60	°C/W
Electrostatic Discharge Threshold (HBM)		8000	V

Notes:

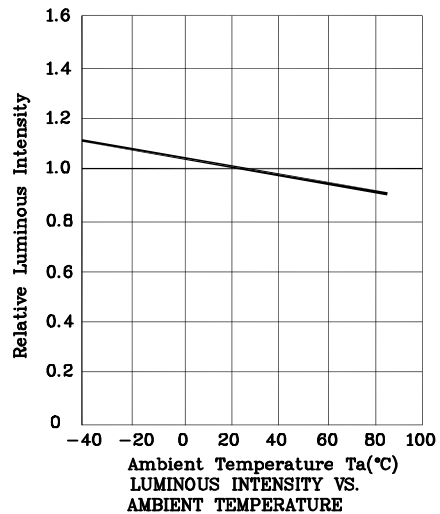
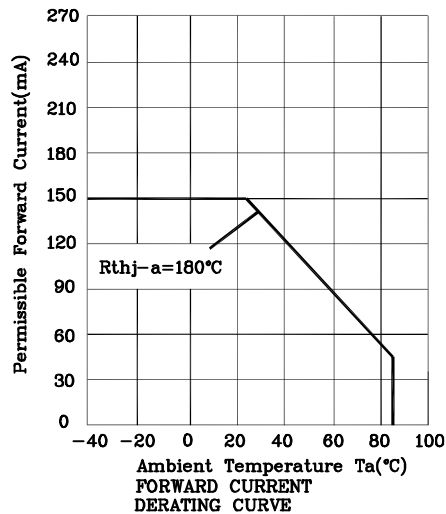
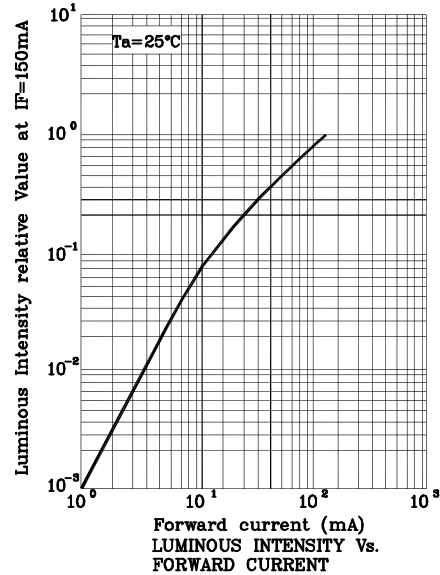
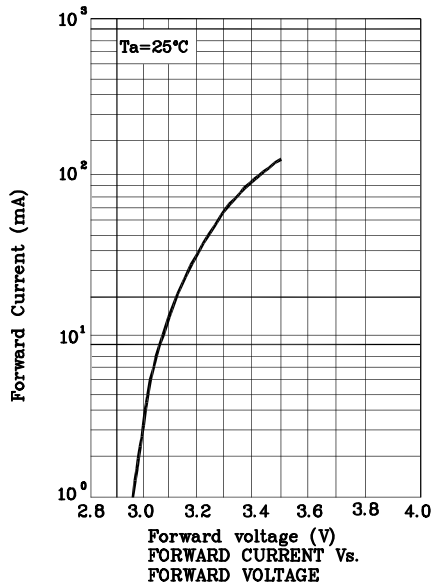
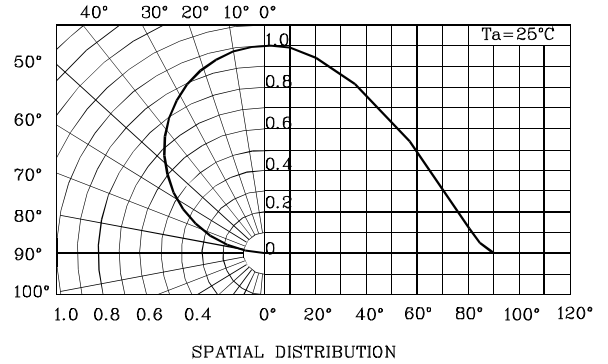
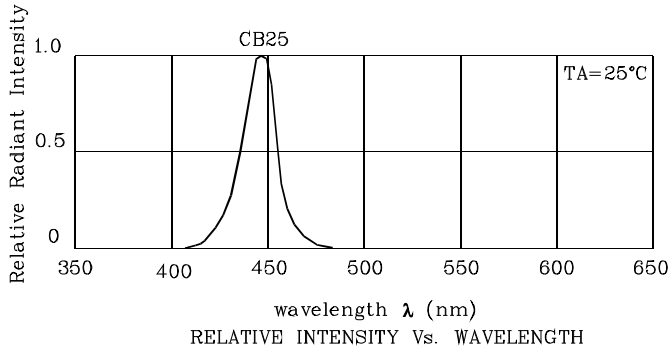
- Results from mounting on PC board FR4(pad size ≥ 70mm<sup>2</sup>), mounted on pc board-metal core PCB is recommend for lowest thermal Resistance.
- 2 θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 3.1/10 Duty Cycle, 0.1ms Pulse Width.

**Electrical / Optical Characteristics at TA=25°C**

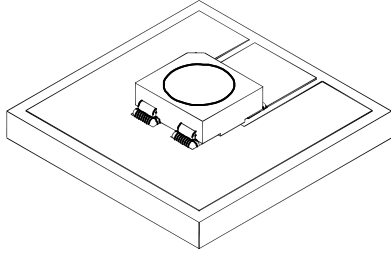
Parameter	Symbol	Value	Unit
Forward Voltage IF = 150mA [Min.]	VF [2]	2.7	V
Forward Voltage IF = 150mA [Typ.]		3.5	
Forward Voltage IF = 150mA [Max.]		4.0	
Allowable Reverse Current [Max.]	IR	85	mA
Wavelength at peak emission IF = 150mA [Typ.]	λ peak	445	nm
Dominant Wavelength IF = 150mA [Typ.]	λ dom [1]	450	nm
Spectral bandwidth at 50% Φ REL MAX IF = 150mA [Typ.]	Δλ	20	nm
Temperature coefficient of λ peak IF = 150mA, - 10°C ≤ T ≤ 100°C [Typ.]	TC λ peak	0.12	nm/°C
Temperature coefficient of λ dom IF = 150mA, - 10°C ≤ T ≤ 100°C [Typ.]	TC λ dom	0.10	nm/°C
Temperature coefficient of VF IF = 150mA, - 10°C ≤ T ≤ 100°C [Typ.]	TCv	-2.3	mV/°C

Notes:

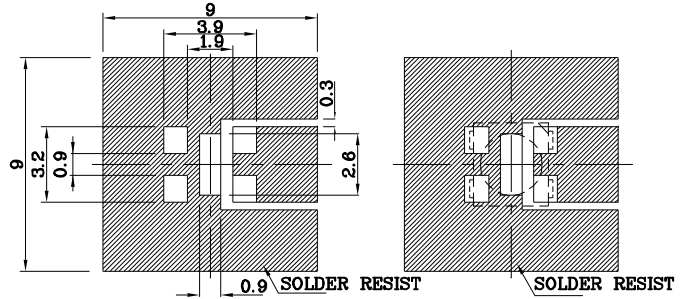
- Wavelength : + / -1nm.
- Forward Voltage : + / - 0.1V.



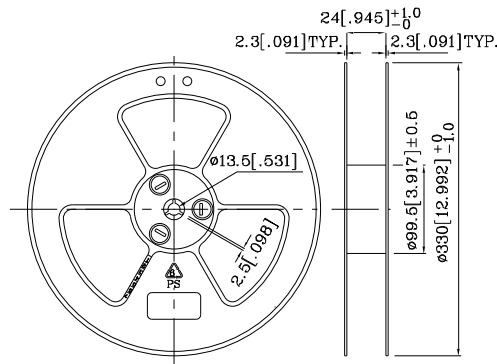
❖ The device has a single mounting surface.  
The device must be mounted according to the specifications.



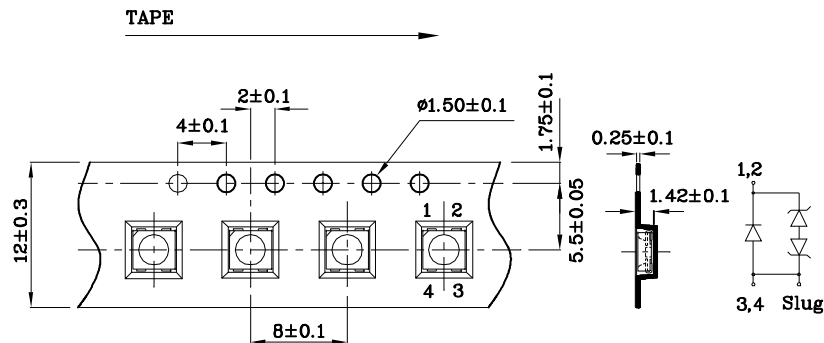
❖ Recommended Soldering Pattern  
(Units : mm; Tolerance: ± 0.1)



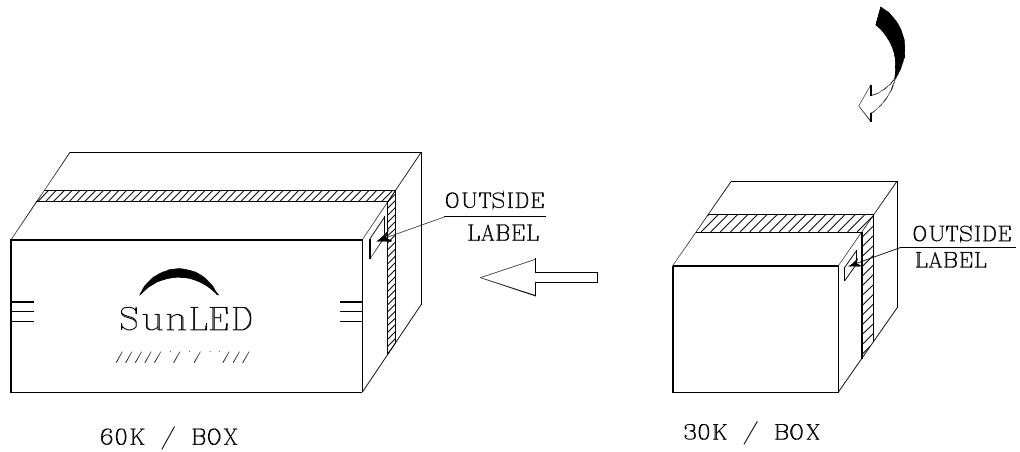
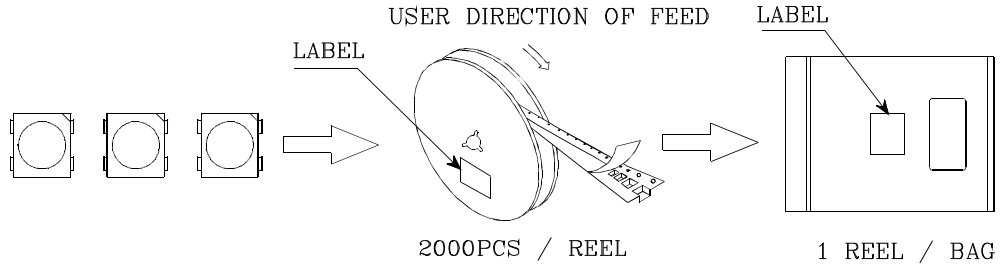

❖ Reel Dimension

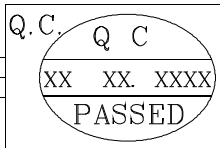



❖ Tape Specification (Units : mm)



PACKING & LABEL SPECIFICATIONS

	
P/NO : XZxxx92x	
QTY : 2000 pcs	CODE: XXX
S/N : XX	
LOT NO :  XXXXXXXXXXXXXXXXXXXXXXXX	
RoHS Compliant	